

# PC900V0NSZX/ PC900V0YSZX

## ■ Features

1. Normal OFF operation, open collector output
2. TTL and LSTTL compatible output
3. Operating supply voltage  $V_{CC}$ :3 to 15V
4. Isolation voltage (Viso (rms)):5kV
5. Recognized by UL, file No.E64380  
Approved by TÜV (VDE0884) (PC900V0YSZX)
6. 6-pin DIP package

## ■ Applications

1. Programmable controllers
2. PC peripherals
3. Electronic musical instruments

## ■ Model Line-up

Model No.	* Safety Standard Approval		Package	Packing
	UL	TÜV (VDE0884)		
PC900V0NSZX	○	—	DIP	Sleeve
PC900V0YSZX	○	○		

\* Application Model No. PC900V

## ■ Absolute Maximum Ratings

( $T_a=25^{\circ}\text{C}$ )

	Parameter	Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	*1 Peak forward current	$I_{FM}$	1	A
	Reverse voltage	$V_R$	6	V
	Power dissipation	P	70	mW
Output	Supply voltage	$V_{CC}$	16	V
	High level output voltage	$V_{OH}$	16	V
	Low level output current	$I_{OL}$	50	mA
	Power dissipation	$P_O$	150	mW
	Total power dissipation	$P_{tot}$	170	mW
	*2 Isolation voltage	$V_{iso}$ (rms)	5	kV
	Operating temperature	$T_{opr}$	-25 to +85	$^{\circ}\text{C}$
	Storage temperature	$T_{stg}$	-40 to +125	$^{\circ}\text{C}$
	*3 Soldering temperature	$T_{sol}$	260	$^{\circ}\text{C}$

\*1 Pulse width $\leq 100\mu\text{s}$ , Duty ratio=0.001

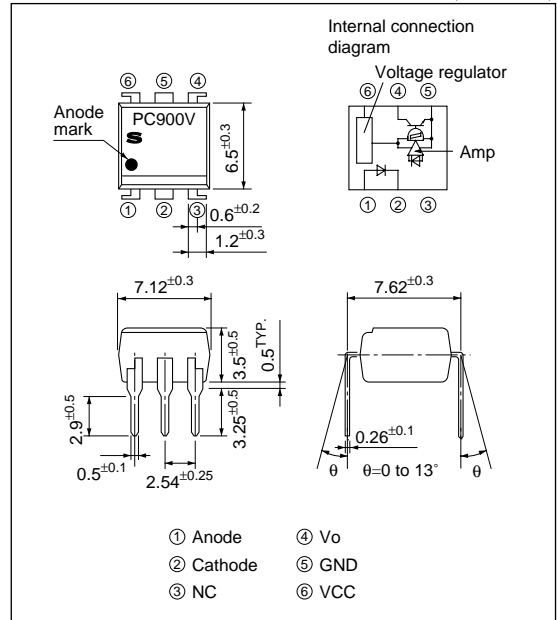
\*2 40 to 60%RH, AC for 1 min

\*3 For 10 s

## Digital Output Type OPIC Photocoupler

## ■ Outline Dimensions

(Unit : mm)



\* "OPIC"(Optical IC) is a trademark of the SHARP Corporation.  
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Electro-optical Characteristics

(Ta=0 to 70°C unless spesified)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =4mA	-	1.1	1.4	V
			I <sub>F</sub> =0.3mA	0.7	1.0	-	
	Reverse current	I <sub>R</sub>	Ta=25°C, V <sub>R</sub> =3V	-	-	10	μA
	Terminal capacitance	C <sub>t</sub>	Ta=25°C, V=0, f=1kHz	-	30	250	pF
Output	Operating supply voltage	V <sub>CC</sub>		3	-	15	V
	Low level output voltage	V <sub>OL</sub>	I <sub>oL</sub> =16mA, V <sub>CC</sub> =5V, I <sub>F</sub> =4mA	-	0.2	0.4	V
	High level output current	I <sub>OH</sub>	V <sub>O</sub> =V <sub>CC</sub> =15V, I <sub>F</sub> =250μA	-	-	100	μA
	Low level supply current	I <sub>CCL</sub>	V <sub>CC</sub> =5.5V, I <sub>F</sub> =0	-	2.5	5.0	mA
	High level supply current	I <sub>CCH</sub>	V <sub>CC</sub> =5V, I <sub>F</sub> =0	-	1.0	5.0	mA
	*4 "High→Low" threshold input current	I <sub>FHL</sub>	Ta=25°C, V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	-	1.1	2.0	mA
			V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	-	-	4.0	
	*5 "Low→High" threshold input current	I <sub>FLH</sub>	Ta=25°C, V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	0.4	0.8	-	mA
			V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	0.3	-	-	
	*6 Hysteresis	I <sub>FLH</sub> /I <sub>FHL</sub>	V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	0.5	0.7	0.9	-
Isolation resistance	R <sub>ISO</sub>	Ta=25°C, DC=500V, 40 to 60%RH	5×10 <sup>10</sup>	10 <sup>11</sup>	-	Ω	
Transfer characteristics	*7 Response time	"High→Low" propagation delay time	Ta=25°C V <sub>CC</sub> =5V, I <sub>F</sub> =4mA R <sub>L</sub> =280Ω	-	1	3	μs
		"Low→High" propagation delay time		-	2	6	
		Fall time		-	0.05	0.5	
		Rise time		-	0.1	0.5	

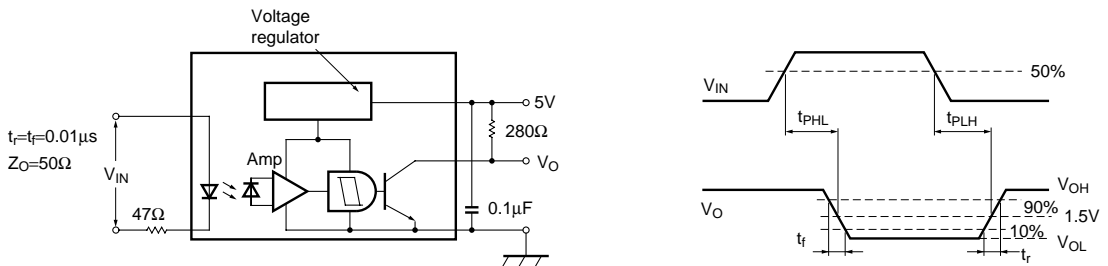
\*4 I<sub>FHL</sub> represents forward current when output goes from high to low.

\*5 I<sub>FLH</sub> represents forward current when output goes from low to high.

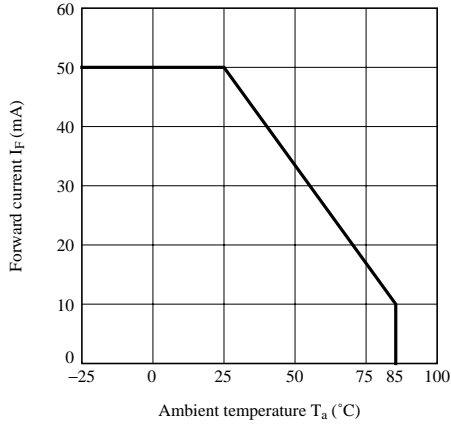
\*6 Hysteresis stands for I<sub>FLH</sub>/I<sub>FHL</sub>.

\*7 Test circuit for response time is shown below.

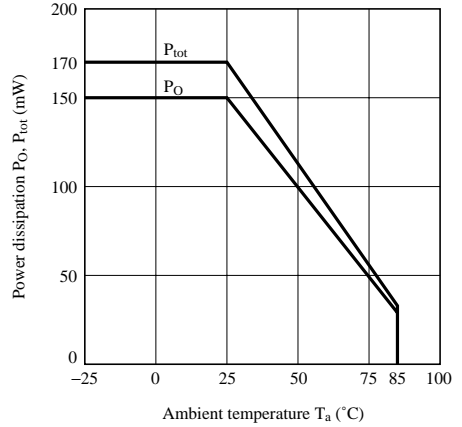
Fig.1 Test Circuit for Response Time



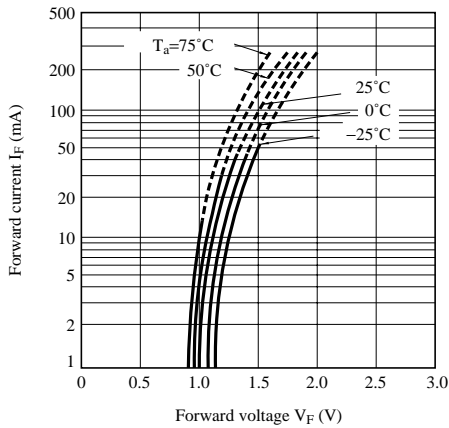
**Fig.2 Forward Current vs. Ambient Temperature**



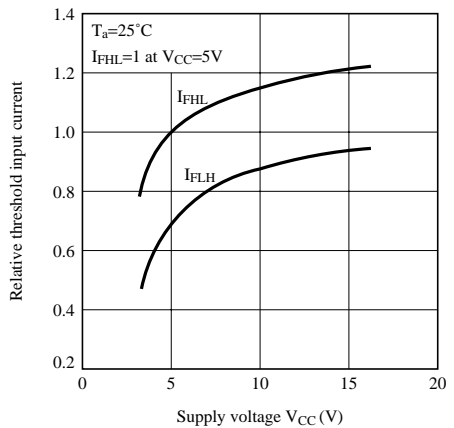
**Fig.3 Power Dissipation vs. Ambient Temperature**



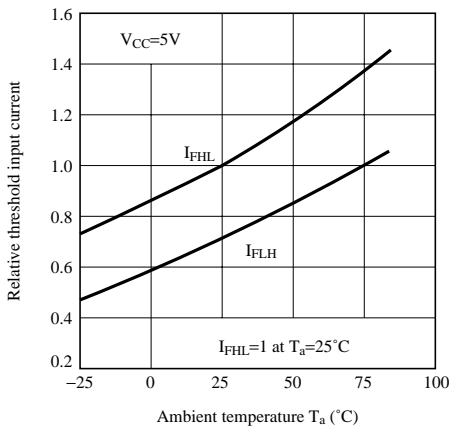
**Fig.4 Forward Current vs. Forward Voltage**



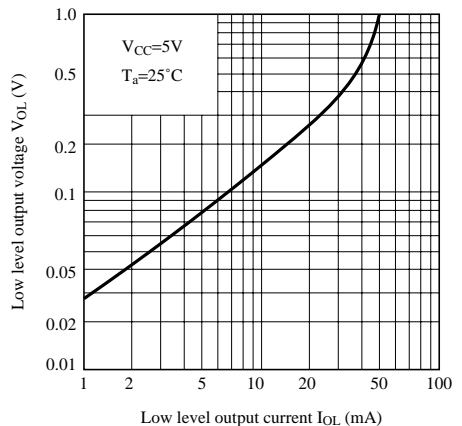
**Fig.5 Relative Threshold Input Current vs. Supply Voltage**



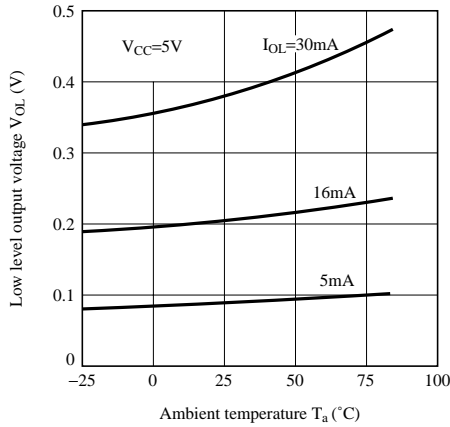
**Fig.6 Relative Threshold Input Current vs. Ambient Temperature**



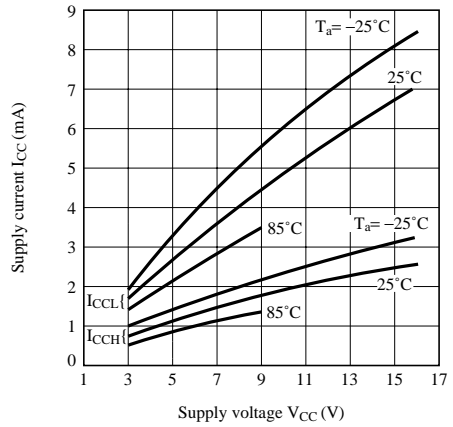
**Fig.7 Low Level Output Voltage vs. Low Level Output Current**



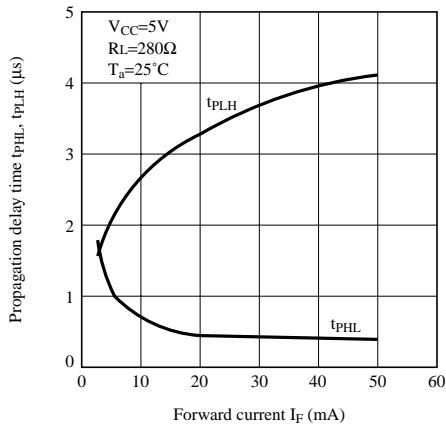
**Fig.8 Low Level Output Voltage vs. Ambient Temperature**



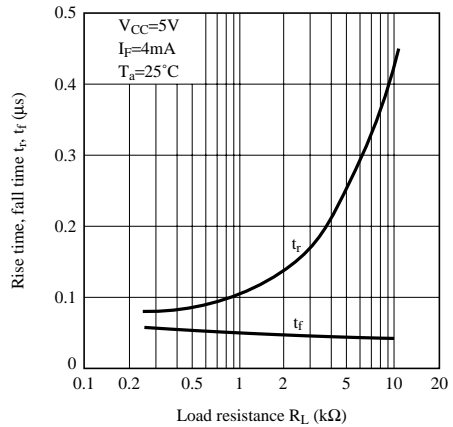
**Fig.9 Supply Current vs. Supply Voltage**



**Fig.10 Propagation Delay Time vs. Forward Current**



**Fig.11 Rise Time, Fall Time vs. Load Resistance**



**■ Precautions for Use**

1. It is recommended that a by-pass capacitor of more than 0.01μF is added between  $V_{CC}$  and GND near the device in order to stabilize power supply line.
2. Handle this product the same as with other integrated circuits against static electricity.

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  - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
    - Personal computers
    - Office automation equipment
    - Telecommunication equipment [terminal]
    - Test and measurement equipment
    - Industrial control
    - Audio visual equipment
    - Consumer electronics
  - (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
    - Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
    - Traffic signals
    - Gas leakage sensor breakers
    - Alarm equipment
    - Various safety devices, etc.
  - (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
    - Space applications
    - Telecommunication equipment [trunk lines]
    - Nuclear power control equipment
    - Medical and other life support equipment (e.g., scuba).
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# PC900V0NIZX/ PC900V0NIPX

## ■ Features

1. Normal OFF operation, open collector output
2. TTL and LSTTL compatible output
3. Operating supply voltage  $V_{CC}$ : 3 to 15V
4. Isolation voltage (Viso (rms)): 5kV
5. Recognized by UL, file No.E64380
6. 6-pin DIP package (Lead forming type)

## ■ Applications

1. Programmable controllers
2. PC peripherals
3. Electronic musical instruments

## ■ Model Line-up

Model No.	* Safty Standard Approval		Package	Packing
	UL	TÜV (VDE0884)		
PC900V0NIZX	○	—	Surface Mount	Sleeve
PC900V0NIPX	○	—	Mount	Taping

\* Application Model No. PC900V

## ■ Absolute Maximum Ratings

( $T_a=25^{\circ}\text{C}$ )

	Parameter	Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	<sup>*1</sup> Peak forward current	$I_{FM}$	1	A
	Reverse voltage	$V_R$	6	V
	Power dissipation	P	70	mW
Output	Supply voltage	$V_{CC}$	16	V
	High level output voltage	$V_{OH}$	16	V
	Low level output current	$I_{OL}$	50	mA
	Power dissipation	$P_O$	150	mW
	Total power dissipation	$P_{tot}$	170	mW
	<sup>*2</sup> Isolation voltage	$V_{iso}$ (rms)	5	kV
	Operating temperature	$T_{opr}$	-25 to +85	$^{\circ}\text{C}$
	Storage temperature	$T_{stg}$	-40 to +125	$^{\circ}\text{C}$
	<sup>*3</sup> Soldering temperature	$T_{sol}$	260	$^{\circ}\text{C}$

\*1 Pulse width $\leq$ 100 $\mu$ s, Duty ratio=0.001

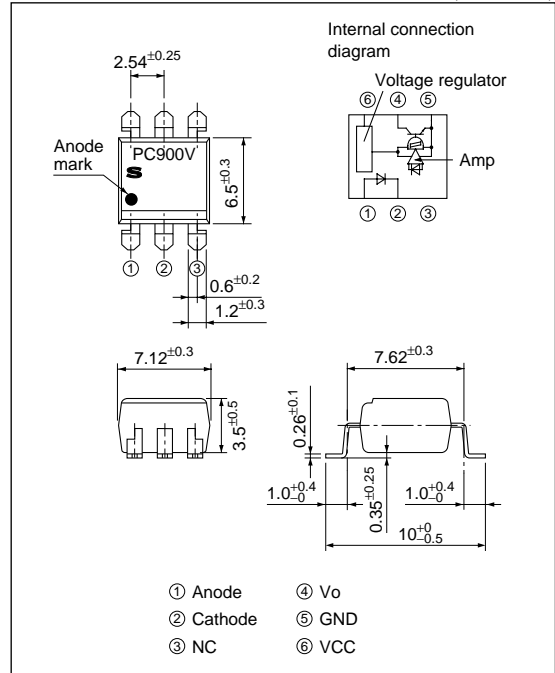
\*2 40 to 60%RH, AC for 1 min

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## Digital Output Type OPIC Photocoupler

## ■ Outline Dimensions

(Unit : mm)



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An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Electro-optical Characteristics

(Ta=0 to 70°C unless spesified)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =4mA	-	1.1	1.4	V
			I <sub>F</sub> =0.3mA	0.7	1.0	-	
	Reverse current	I <sub>R</sub>	Ta=25°C, V <sub>R</sub> =3V	-	-	10	μA
	Terminal capacitance	C <sub>t</sub>	Ta=25°C, V=0, f=1kHz	-	30	250	pF
Output	Operating supply voltage	V <sub>CC</sub>		3	-	15	V
	Low level output voltage	V <sub>OL</sub>	I <sub>oL</sub> =16mA, V <sub>CC</sub> =5V, I <sub>F</sub> =4mA	-	0.2	0.4	V
	High level output current	I <sub>OH</sub>	V <sub>O</sub> =V <sub>CC</sub> =15V, I <sub>F</sub> =250μA	-	-	100	μA
	Low level supply current	I <sub>CCL</sub>	V <sub>CC</sub> =5.5V, I <sub>F</sub> =0	-	2.5	5.0	mA
	High level supply current	I <sub>CCH</sub>	V <sub>CC</sub> =5V, I <sub>F</sub> =0	-	1.0	5.0	mA
	*4 "High→Low" threshold input current	I <sub>FHL</sub>	Ta=25°C, V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	-	1.1	2.0	mA
			V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	-	-	4.0	
	*5 "Low→High" threshold input current	I <sub>FLH</sub>	Ta=25°C, V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	0.4	0.8	-	mA
			V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	0.3	-	-	
	*6 Hysteresis	I <sub>FLH</sub> /I <sub>FHL</sub>	V <sub>CC</sub> =5V, R <sub>L</sub> =280Ω	0.5	0.7	0.9	-
Isolation resistance	R <sub>ISO</sub>	Ta=25°C, DC=500V, 40 to 60%RH	5×10 <sup>10</sup>	10 <sup>11</sup>	-	Ω	
Transfer characteristics	*7 Response time	"High→Low" propagation delay time	Ta=25°C V <sub>CC</sub> =5V, I <sub>F</sub> =4mA R <sub>L</sub> =280Ω	-	1	3	μs
		"Low→High" propagation delay time		-	2	6	
		Fall time		-	0.05	0.5	
		Rise time		-	0.1	0.5	

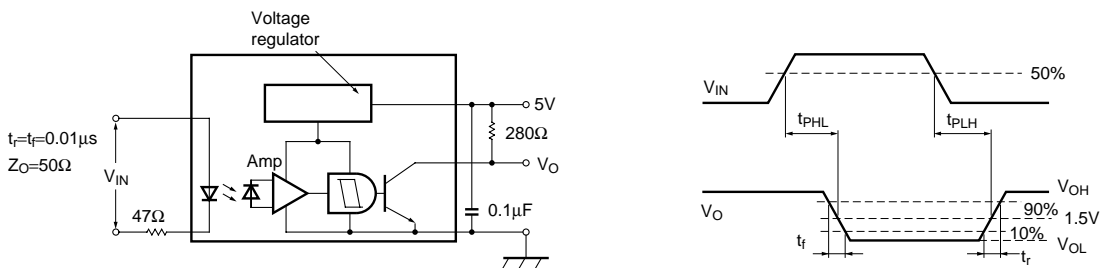
\*4 I<sub>FHL</sub> represents forward current when output goes from high to low.

\*5 I<sub>FLH</sub> represents forward current when output goes from low to high.

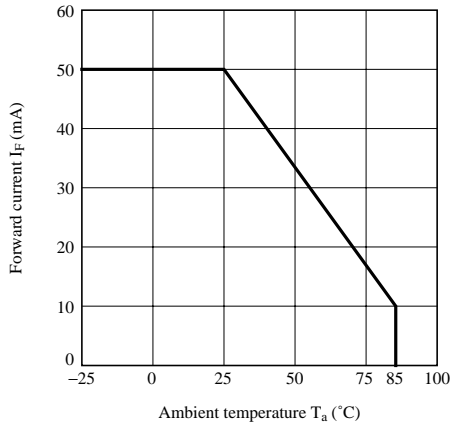
\*6 Hysteresis stands for I<sub>FLH</sub>/I<sub>FHL</sub>.

\*7 Test circuit for response time is shown below.

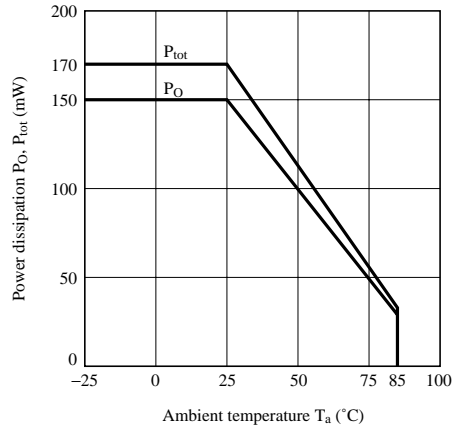
Fig.1 Test Circuit for Response Time



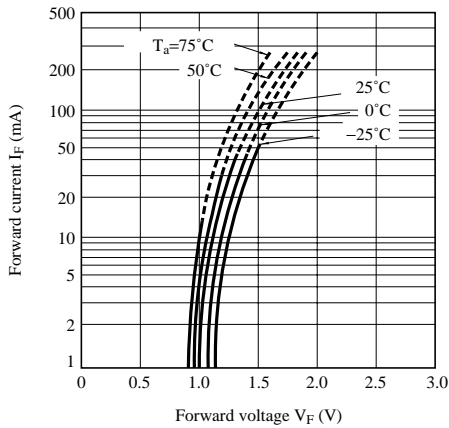
**Fig.2 Forward Current vs. Ambient Temperature**



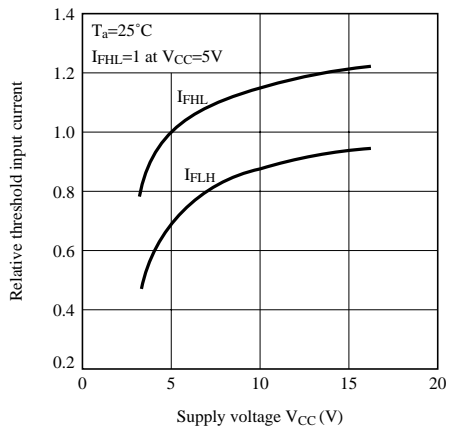
**Fig.3 Power Dissipation vs. Ambient Temperature**



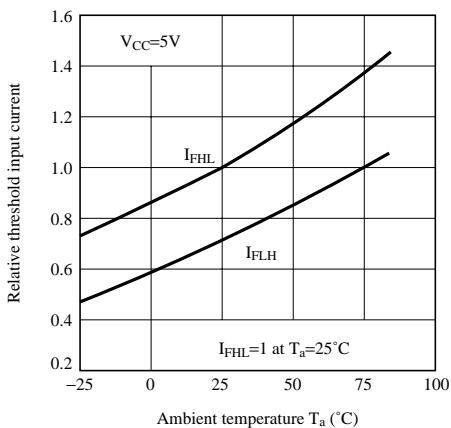
**Fig.4 Forward Current vs. Forward Voltage**



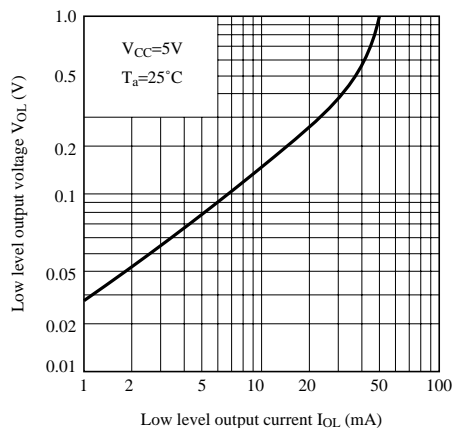
**Fig.5 Relative Threshold Input Current vs. Supply Voltage**



**Fig.6 Relative Threshold Input Current vs. Ambient Temperature**

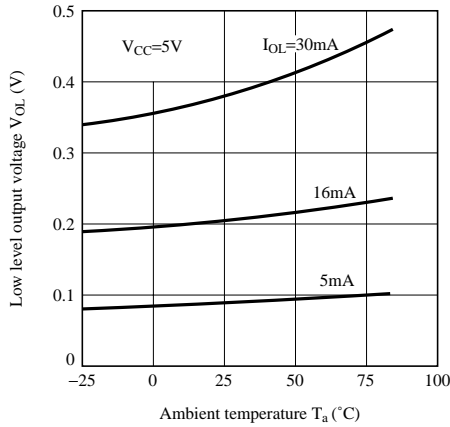


**Fig.7 Low Level Output Voltage vs. Low Level Output Current**

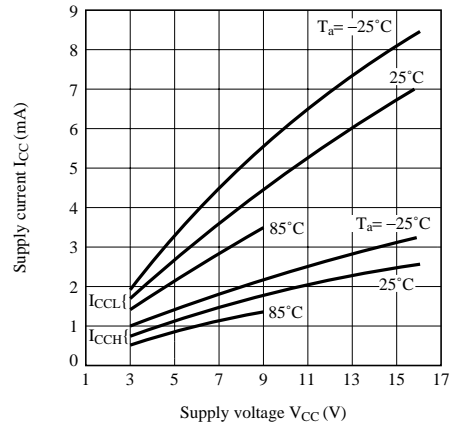




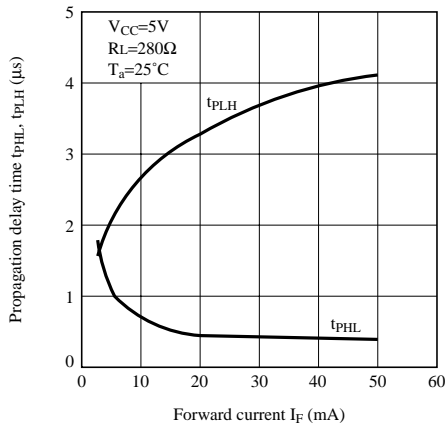
**Fig.8 Low Level Output Voltage vs. Ambient Temperature**



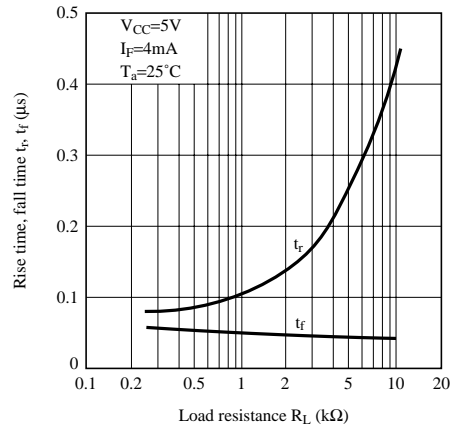
**Fig.9 Supply Current vs. Supply Voltage**



**Fig.10 Propagation Delay Time vs. Forward Current**



**Fig.11 Rise Time, Fall Time vs. Load Resistance**



**Precautions for Use**

1. It is recommended that a by-pass capacitor of more than  $0.01\mu F$  is added between  $V_{CC}$  and GND near the device in order to stabilize power supply line.
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